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<u>MOSFET</u> - Power, Single N-Channel, DFN5/DFNW5 60 V, 4.7 mΩ, 93 A

NVMFS5C646NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C646NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

	ι J		,		
Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	60	V
Gate-to-Source Voltage	Gate-to-Source Voltage			±20	V
Continuous Drain		$T_{C} = 25^{\circ}C$	۱ _D	93	А
Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C		65	
Power Dissipation	State	T _C = 25°C	PD	79	W
R _{θJC} (Note 1)		$T_{\rm C} = 100^{\circ}{\rm C}$		40	
Continuous Drain		$T_A = 25^{\circ}C$	۱ _D	20	А
Current R _{θJA} (Notes 1, 2, 3)	Steady	teady T _A = 100°C		14	
Power Dissipation	State	$T_A = 25^{\circ}C$	PD	3.7	W
R _{θJA} (Notes 1 & 2)		$T_A = 100^{\circ}C$		1.8	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	750	А
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			IS	100	А
Single Pulse Drain-to-Source Avalanche Energy $(I_{L(pk)} = 5 A)$			E _{AS}	185	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

MAXIMUM RATINGS (T, I = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

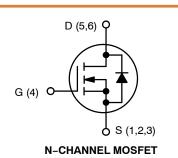
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.9	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	41	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
60 V	4.7 m Ω @ 10 V	00.4	
	$6.3~\mathrm{m}\Omega$ @ $4.5~\mathrm{V}$	93 A	

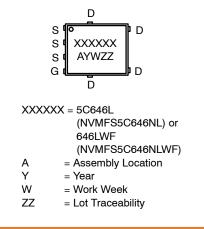




DFN5 (SO-8FL) CASE 488AA

DFNW5 (FULL-CUT SO8FL WF) CASE 507BA

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet. NOTE: Some of the device on this data sheet have been **DISCONTINUED**. Please refer to the table on page 5

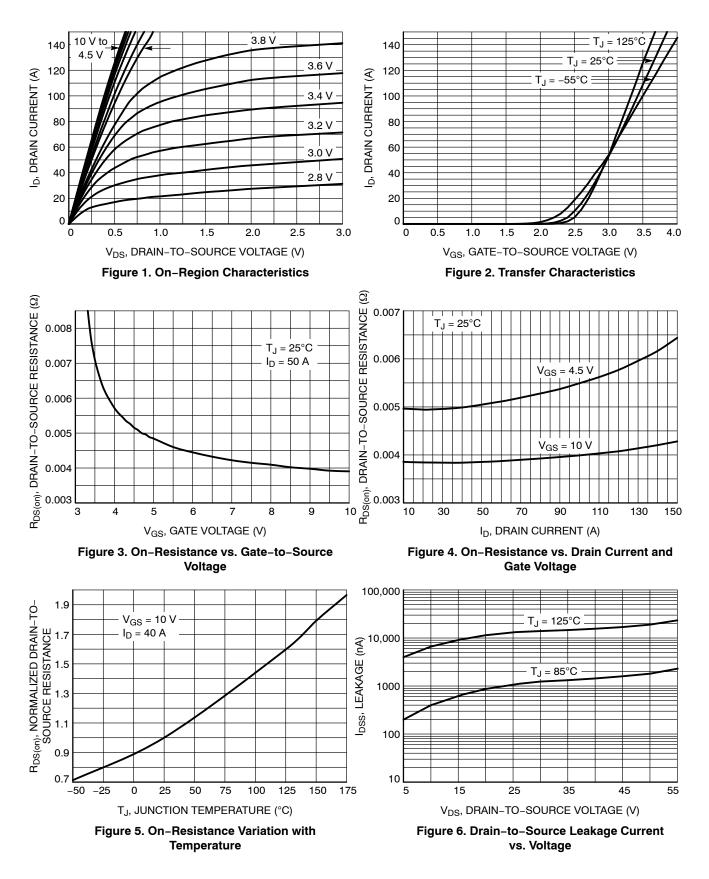
ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS								
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 µA		60			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				15.5		mV/°C	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	T _J = 25 °C			10		
		$V_{\rm DS} = 60 \text{ V}$	T _J = 125°C			250	μΑ	
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = ±16 V				±100	nA	
ON CHARACTERISTICS (Note 4)								
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 80 \ \mu A$		1.2		2.0	V	
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-4.9		mV/°C	
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		3.8	4.7		
		V _{GS} = 4.5 V	I _D = 50 A		5.0	6.3	mΩ	
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I	_D = 50 A		105		S	
CHARGES, CAPACITANCES & GATE RE	SISTANCE							
Input Capacitance	C _{ISS}				2164			
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MH	lz, V _{DS} = 25 V		900		pF	
Reverse Transfer Capacitance	C _{RSS}				17			
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 30 V; I_{D} = 25 A			15.7			
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 30 V; I_D = 25 A			33.7			
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 25 A			1.5		nC	
Gate-to-Source Charge	Q _{GS}				5.6			
Gate-to-Drain Charge	Q _{GD}				5.1			
Plateau Voltage	V _{GP}				2.8		V	
SWITCHING CHARACTERISTICS (Note 5	5)					-		
Turn-On Delay Time	t _{d(ON)}				10.4			
Rise Time	t _r	V _{GS} = 4.5 V, V _E	_{ns} = 30 V,		14.9			
Turn-Off Delay Time	t _{d(OFF)}	$I_D = 25 \text{ A}, \text{ R}_G = 2.5 \Omega$			23.6		ns	
Fall Time	t _f				5.1			
DRAIN-SOURCE DIODE CHARACTERIS	TICS						•	
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.88	1.2		
		$I_{\rm S} = 50 \text{ A}$ $T_{\rm J} = 125^{\circ} \text{C}$			0.78		V	
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 50 A			40.9			
Charge Time	t _a				20.8		ns	
Discharge Time	t _b				20.1		1	
Reverse Recovery Charge	Q _{RR}				32		nC	

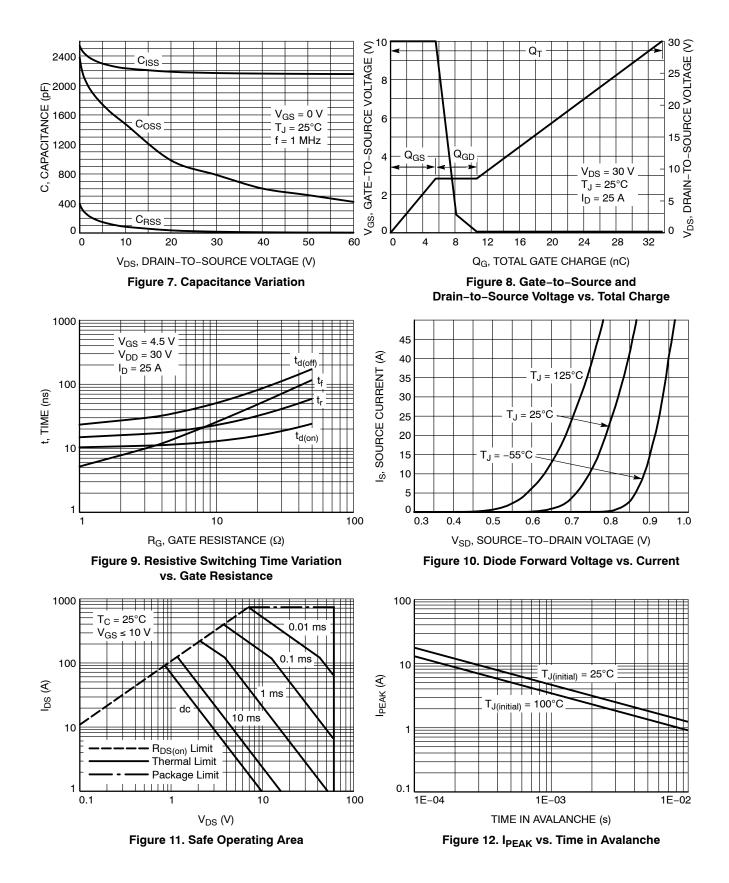
 $\begin{array}{ll} \mbox{4. Pulse Test: pulse width } \le 300 \ \mu \mbox{s, duty cycle } \le 2 \mbox{\%}. \\ \mbox{5. Switching characteristics are independent of operating junction temperatures.} \end{array}$

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



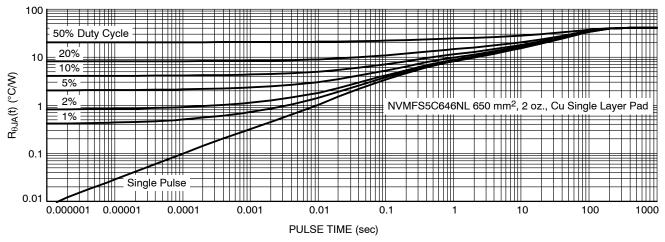


Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS5C646NLT1G	5C646L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C646NLAFT1G	5C646L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C646NLAFT1G-YE	5C646L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C646NLWFAFT1G	646LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C646NLWFET1G	646LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

DISCONTINUED (Note 5)

Device	Package Type	Package	Shipping [†]
NVMFS5C646NLWFT1G	646LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C646NLT3G	5C646L	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS5C646NLWFT3G	646LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel

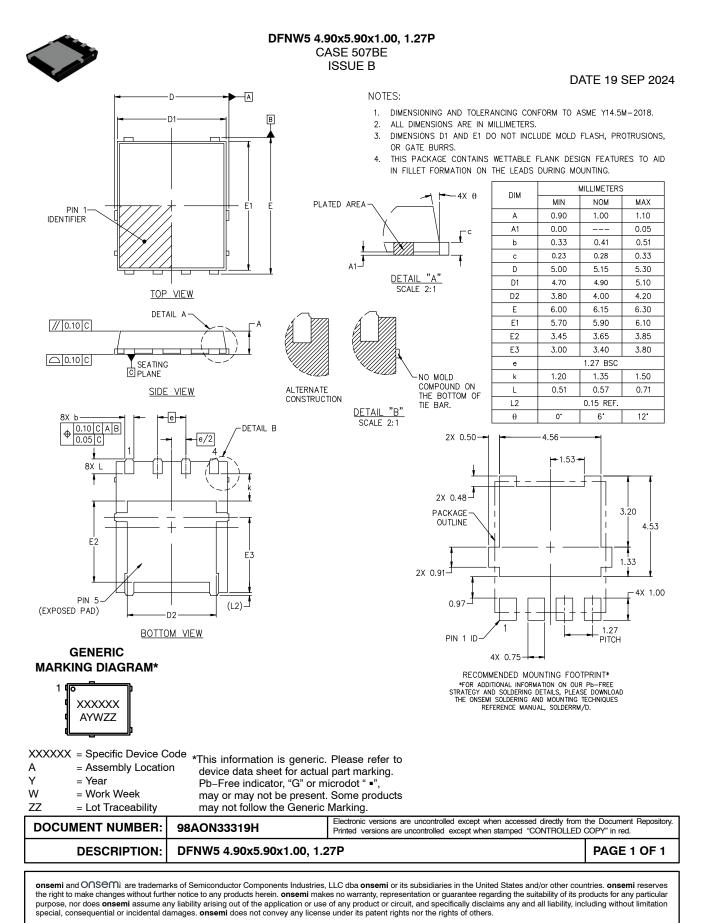
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

6. **DISCONTINUED:** This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on <u>www.onsemi.com</u>.

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